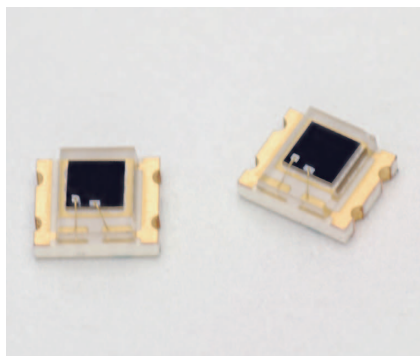


Si photodiode



S10625-01CT

COB type, applicable to lead-free solder reflow

The S10625-01CT is a Si photodiode for visible to near infrared range and is compatible with lead-free solder reflow processes. The small and thin leadless package allows reducing the mount area on a printed circuit board.

Features

- COB type
- Small package: 3.2 × 2.7 × 1.1^t mm
- Applicable to lead-free solder reflow
- Photosensitive area: 1.3 × 1.3 mm

Applications

- Optical switches

Structure

Parameter	Specification	Unit
Photosensitive area	1.3 × 1.3	mm
Package	Glass epoxy	-
Seal material	Epoxy resin	-

Absolute maximum ratings

Parameter	Symbol	Condition	Value	Unit
Reverse voltage	V _R max	T _a =25 °C	10	V
Operating temperature	T _{opr}		-25 to +85	°C
Storage temperature	T _{stg}		-40 to +100	°C
Reflow soldering conditions*1	T _{sol}		Peak temperature 240 °C max., 1 time (see page 5)	-

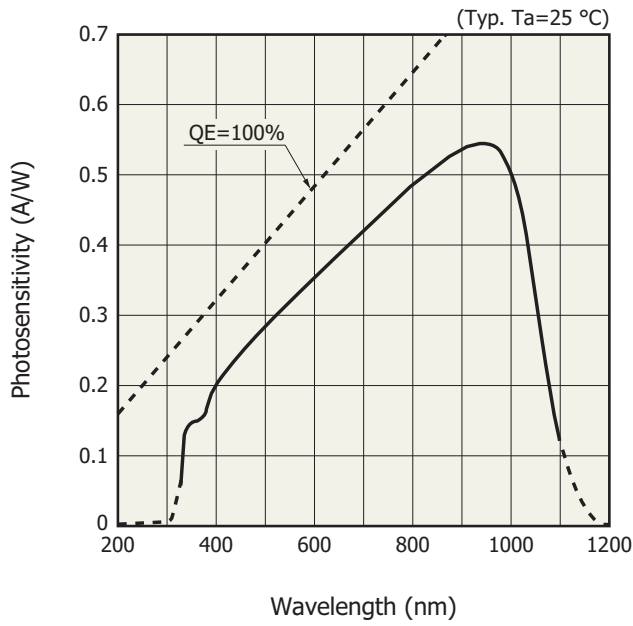
Note: Exceeding the absolute maximum ratings even momentarily may cause a drop in product quality. Always be sure to use the product within the absolute maximum ratings.

*1: JEDEC level 4

Electrical and optical characteristics (T_a=25 °C)

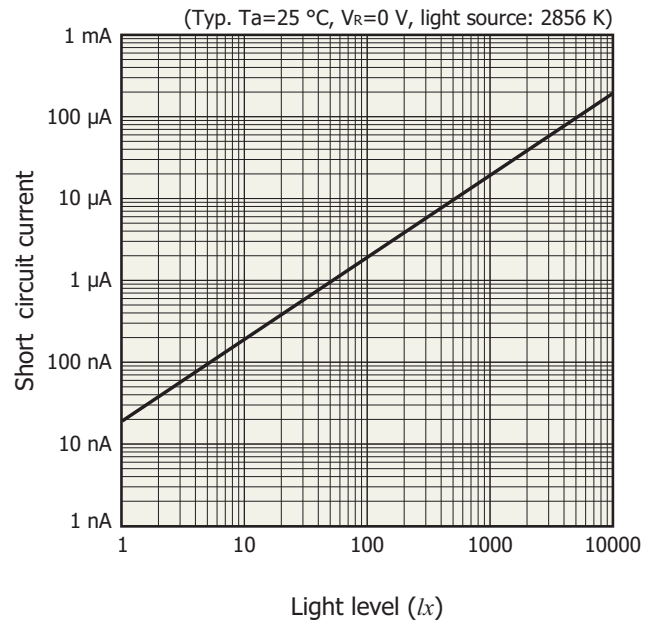
Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Spectral response range	λ		-	320 to 1100	-	nm
Peak sensitivity wavelength	λ _p		-	940	-	nm
Photosensitivity	S	λ=λ _p	-	0.54	-	A/W
Short circuit current	I _{sc}	100 lx, 2856K	1.4	1.9	2.4	μA
Dark current	I _D	V _R =1 V	-	0.01	10	nA
Temperature coefficient of I _D	T _{CI_D}		-	1.12	-	times/°C
Rise time	t _r	V _R =0 V, R _L =1 KΩ 10 to 90%	-	0.5	-	μs
Terminal capacitance	C _t	V _R =0 V, f=10 kHz	-	200	400	pF

Spectral response



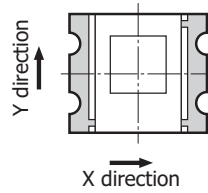
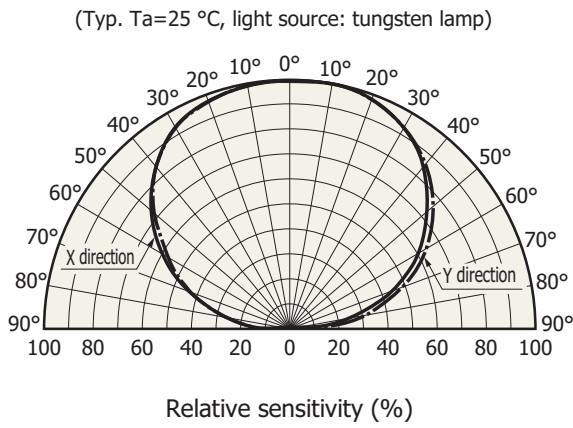
KSPD80310EA

Short circuit current vs. light level



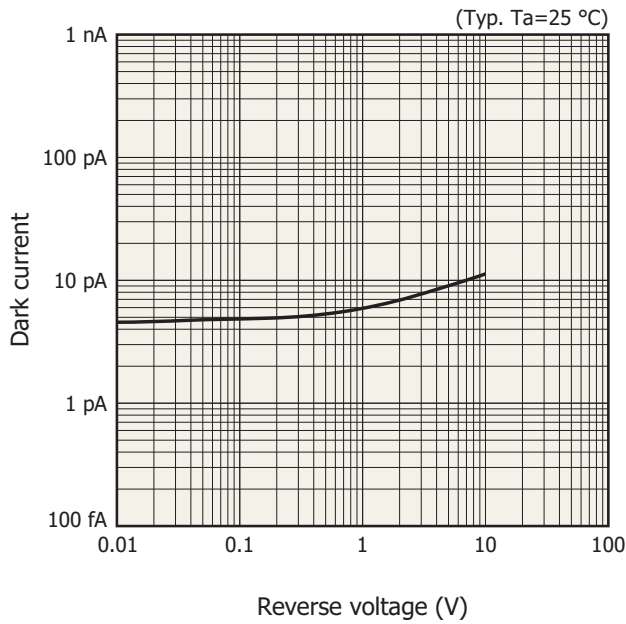
KSPD80311EA

Directivity



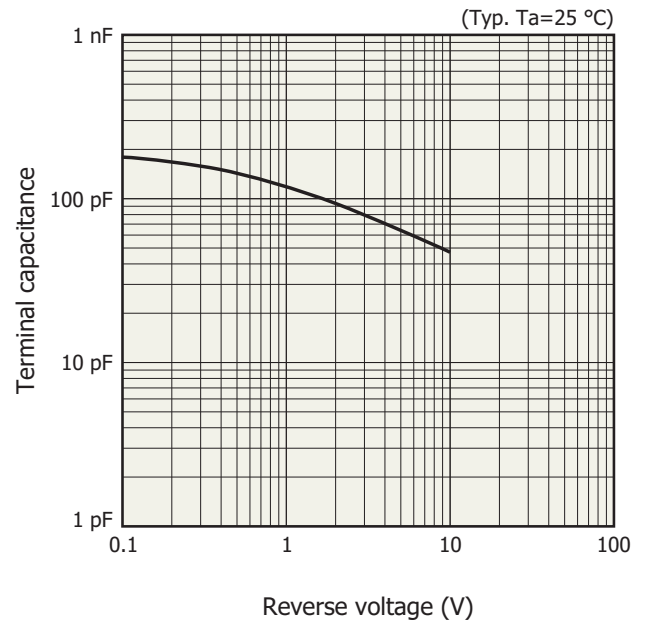
KSPD80312EA

Dark current vs. reverse voltage



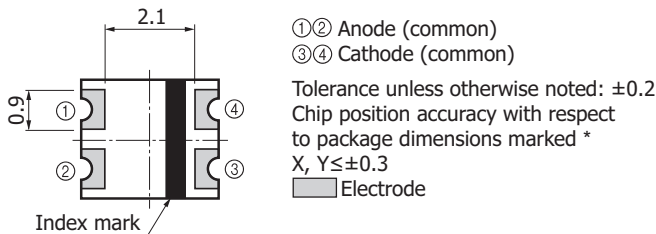
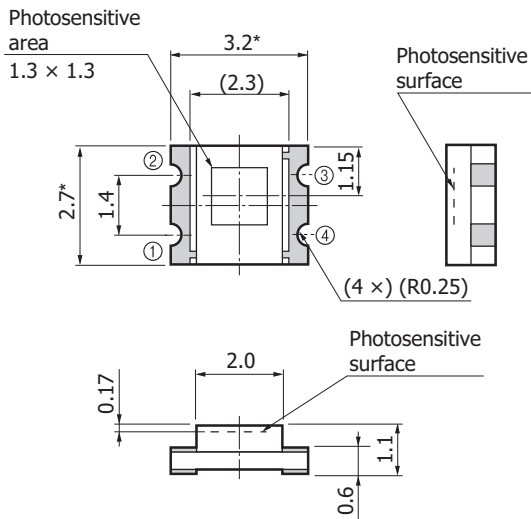
KSPD80337EA

Terminal capacitance vs. reverse voltage



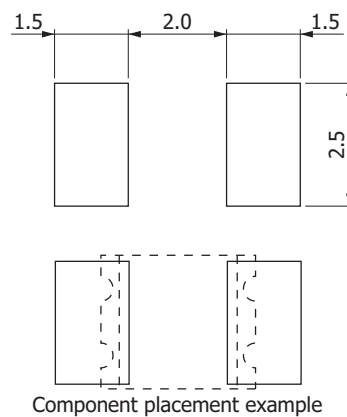
KSPD80338EA

Dimensional outlines (unit: mm)



KSPDA0207EA

Recommended land pattern (unit: mm)



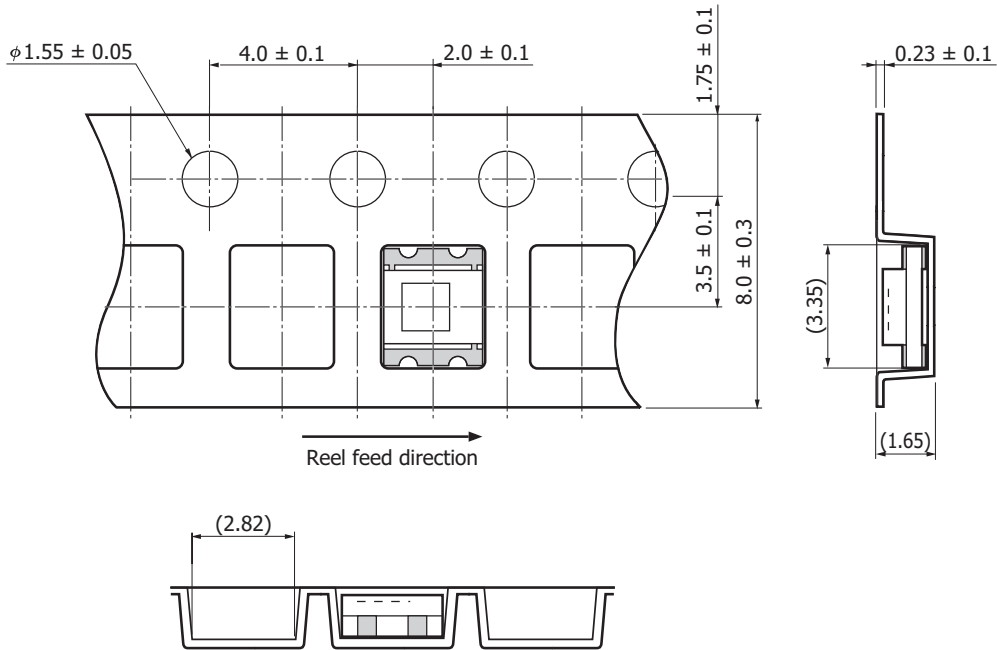
KSPDC0084EA

Standard packing specifications

- Reel (conforms to JEITA ET-7200)

Dimensions	Hub diameter	Tape width	Material	Electrostatic characteristics
178 mm	60 mm	8 mm	PS	-

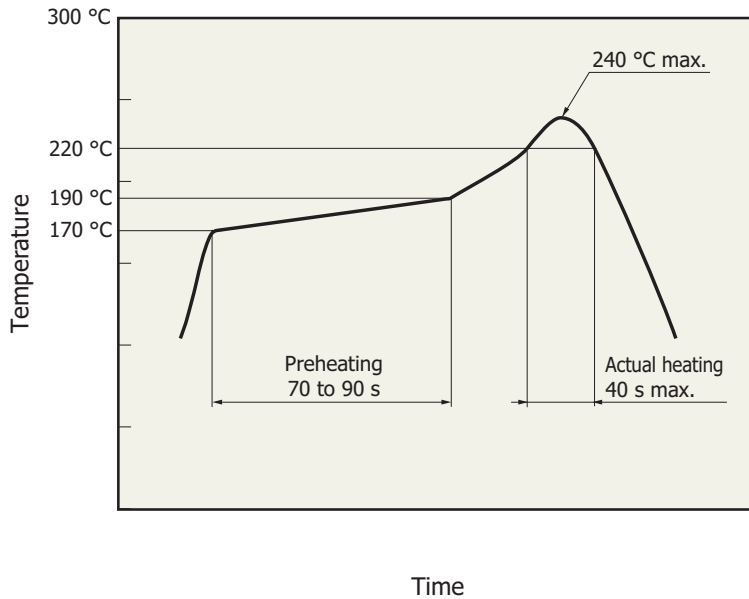
- Embossed tape (unit: mm, material: PC)



KPINC0024EA

- Packing quantity
2000 pcs/reel
- Packing type
Reel and desiccant in moisture-proof packaging (vacuum-sealed)

Measured example of temperature profile with our hot-air reflow oven for product testing



KSPDB0313EC

- This product supports lead-free soldering. After unpacking, store it in an environment at a temperature of 30 °C or less and a humidity of 60% or less, and perform soldering within 72 hours.
- The effect that the product receives during reflow soldering varies depending on the circuit board and reflow oven that are used. Before actual reflow soldering, check for any problems by tesitng out the reflow soldering methods in advance.

Related information

www.hamamatsu.com/sp/ssd/doc_en.html

■ Precautions

- Disclaimer
- Surface mount type products

■ Technical information

- Si photodiode / Application circuit examples

Information described in this material is current as of July 2017.

Product specifications are subject to change without prior notice due to improvements or other reasons. This document has been carefully prepared and the information contained is believed to be accurate. In rare cases, however, there may be inaccuracies such as text errors. Before using these products, always contact us for the delivery specification sheet to check the latest specifications.

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